

GENESIS Silicon 900 heat sink compound Thermal paste 12.8 W/m·K 8 g

Brand : GENESIS

Product code: NTG-2330

Product name : Silicon 900

8g, 12.8 W/mK, 2.8 g/cm3, -50 - 250 °C
 GENESIS Silicon 900. Type: Thermal paste, Thermal conductivity: 12.8 W/m·K, Density: 2.8 g/cm³.
 Weight: 8 g. Quantity per pack: 1 pc(s)



Features		Weight & dimensions	
Type *	Thermal paste	Weight	8 g
Thermal conductivity	12.8 W/m·K	Packaging data	
Density	2.8 g/cm³	Quantity per pack *	1 pc(s)
Operating temperature (T-T)	-50 - 250 °C	Scraper	✓



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Catalog Object Cloud



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